

PROTECTION PRODUCTS - MicroClamp[®]

Description

The μ Clamp[®]3312T TVS diode is specifically designed to meet the performance requirements of Gigabit Ethernet interfaces. They are designed to protect sensitive PHY chips from damage or upset due to electrostatic discharge (ESD), lightning, electrical fast transients (EFT), and cable discharge events (CDE).

The μ Clamp3312T is constructed using Semtech's low voltage EPD process technology. The EPD process provides low operating voltages with significant reductions in leakage current and capacitance over silicon-avalanche diode processes. The device features low variation in capacitance over bias for stable operation on GbE lines. This means the μ Clamp3312T will introduce zero traffic frame errors on GbE interfaces up to a PHY temperature of 120°C (100M Cat 5/5e Cable). The μ Clamp3312T also features high surge capability and is designed to be placed between the magnetics and the PHY chip. In this configuration, the device can withstand intra-building lightning surges per Telcordia GR-1089.

The μ Clamp3312T is in a 8-pin SLP2010N8T package. It measures 2.0 x 1.0 x 0.4mm. The leads are spaced at a pitch of 0.5mm and are finished with lead-free NiPdAu. Each device will protect two line pairs operating at 3.3 volts. It gives the designer the flexibility to protect multiple lines in applications where space is at a premium. The small size and easy layout of the uClamp3312T make it ideal for use in RJ-45 connectors with integrated magnetics.

Features

- ◆ High ESD withstand Voltage: **+/-30kV** (Contact/Air) per **IEC 61000-4-2**
- ◆ Able to withstand over 1000 ESD strikes per IEC 61000-4-2 Level 4
- ◆ Flow-through design simplifies layout
- ◆ Protects two line pairs
- ◆ Low reverse current: 10nA typical (VR=3.3V)
- ◆ Low variation in capacitance vs. bias voltage: **1.3pF** Typical (VR = 0 to 3.3V)
- ◆ Working voltage: 3.3V
- ◆ Solid-state silicon-avalanche technology

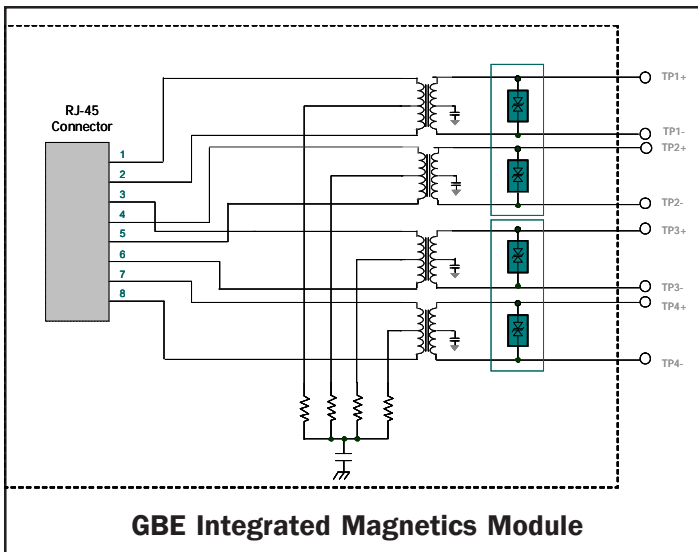
Mechanical Characteristics

- ◆ SLP2010N8T package
- ◆ Pb-Free, Halogen Free, RoHS/WEEE Compliant
- ◆ Nominal Dimensions: 2.0 x 1.0 x 0.4 mm
- ◆ Lead Finish: NiPdAu
- ◆ Molding compound flammability rating: UL 94V-0
- ◆ Marking: Marking code
- ◆ Packaging: Tape and Reel

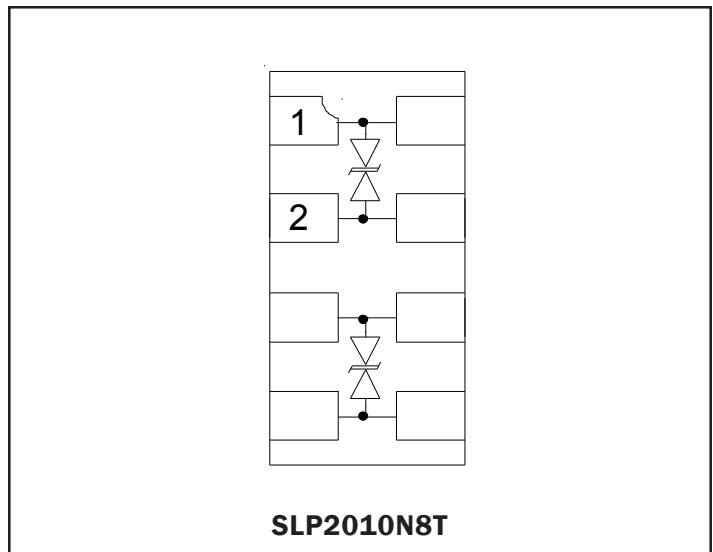
Applications

- ◆ 10/100/1000 Ethernet
- ◆ Integrated magnetics/RJ-45 connectors
- ◆ LAN/WAN Equipment
- ◆ Security Cameras
- ◆ Industrial Controls
- ◆ Notebooks & Desktop Computers

Typical Application



Schematic & PIN Configuration



PROTECTION PRODUCTS

Absolute Maximum Rating

Rating	Symbol	Value	Units
Peak Pulse Power (tp = 8/20μs)	P_{pk}	100	Watts
Maximum Peak Pulse Current (tp = 8/20μs)	I_{pp}	10	Amps
ESD per IEC 61000-4-2 (Air) ESD per IEC 61000-4-2 (Contact)	V_{ESD}	+/- 30 +/- 30	kV
Operating Temperature	T_J	-40 to +85	°C
Storage Temperature	T_{STG}	-55 to +150	°C

Electrical Characteristics (T=25°C)

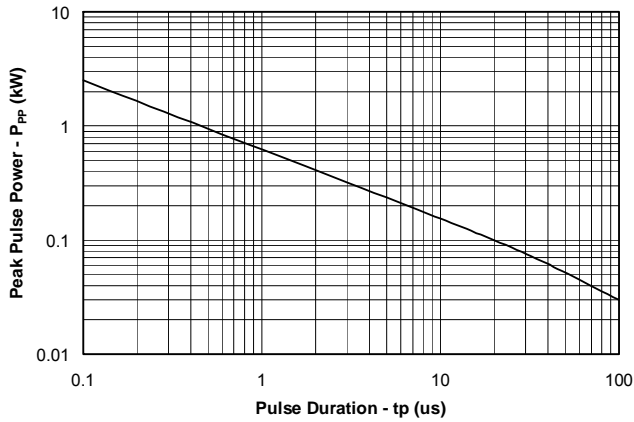
Parameter	Symbol	Conditions	Minimum	Typical	Maximum	Units
Reverse Stand-Off Voltage	V_{RWM}				3.3	V
Punch-Through Voltage	V_{PT}	$I_{PT} = 2\mu A$	3.5	3.8	4.3	V
Snap-Back Voltage	V_{SB}	$I_{SB} = 50mA$	2.8			V
Reverse Leakage Current	I_R	$V_{RWM} = 3.3V$		0.01	0.05	μA
Clamping Voltage	V_C	$I_{pp} = 1A, tp = 8/20\mu s$			5.6	V
Clamping Voltage	V_C	$I_{pp} = 10A, tp = 8/20\mu s$			11	V
Variation in capacitance with reverse bias ¹		Pins 1, 8 to 2, 7 and pins 3, 6 to 4, 5 $V_R = 0$ to 2.5V $f = 1MHz$ Pins 1, 8 to 2, 7 and pins 3, 6 to 4, 5 $V_R = 2.5V, f = 1MHz$		1.3		pF
Junction Capacitance	C_j	I/O pin to Gnd $V_R = 0V, f = 1MHz$		4.5	6	pF

Notes:

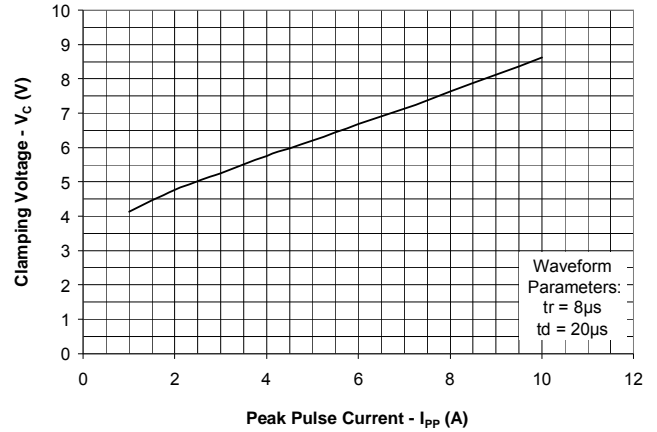
1) This parameter guaranteed by design and characterization and is not production tested

PROTECTION PRODUCTS

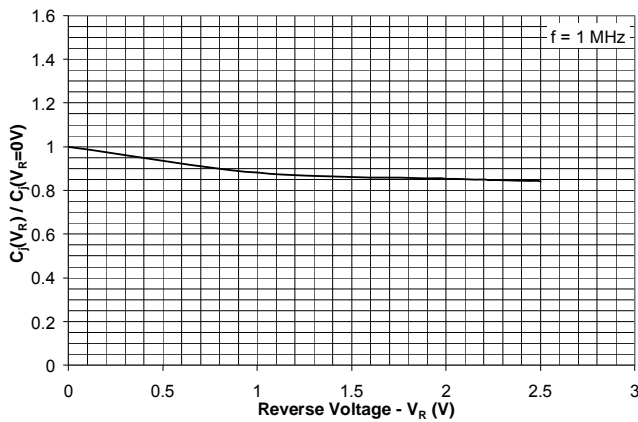
Non-Repetitive Peak Pulse Power vs. Pulse Time



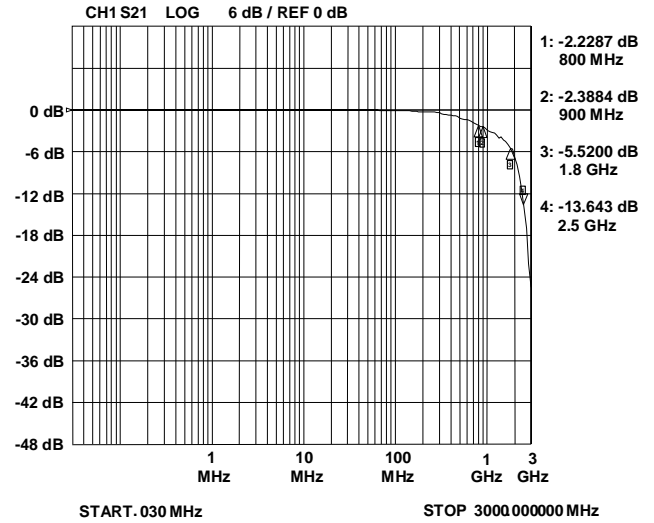
Clamping Voltage vs. Peak Pulse Current



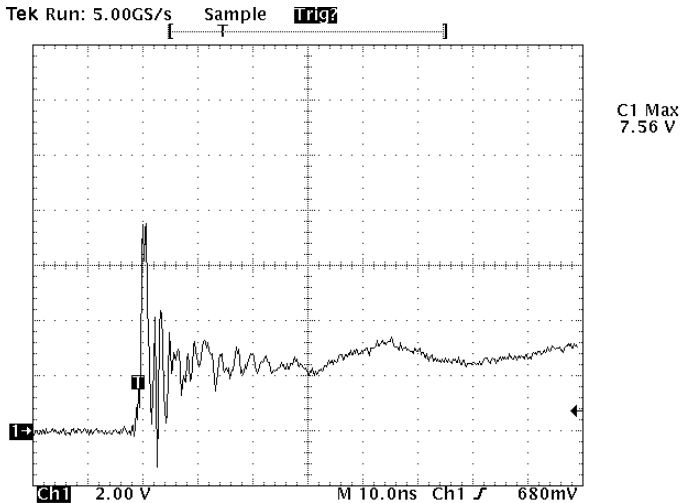
Normalized Junction Capacitance vs. Reverse Voltage



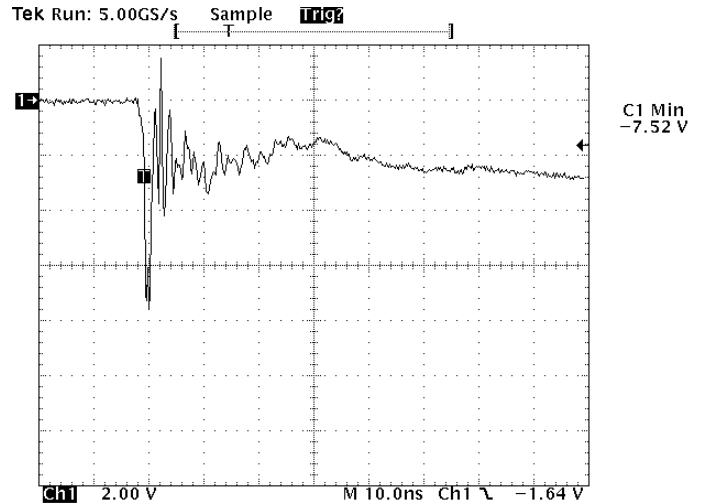
Typical Insertion Loss (S21)



ESD Clamping (Pin 1 to 2 and 2 to 1) (8kV Contact per IEC 61000-4-2)



ESD Clamping (Pin 1 to 2 and 2 to 1) (-8kV Contact per IEC 61000-4-2)



Note: Data is taken with a 10x attenuator

Note: Data is taken with a 10x attenuator

PROTECTION PRODUCTS

Applications Information

Gigabit Ethernet Protection Solutions

Ethernet systems with connections external to the building are subject to high-level transient threats. This type of equipment may even be required to meet the surge immunity requirements of Telcordia GR-1089. Reliable protection of the Ethernet transceiver requires a device that can absorb the expected transient energy, clamp the incoming surge to a safe level, and yet remain transparent to the system under normal operation. The uClamp3312T has been designed to meet these demanding requirements. Typical IEEE 802.3 template test results for a GbE circuit with uClamp3312T are shown in Figure 2.

Transient Protection

When designing Ethernet protection, the entire system must be considered. An Ethernet port includes interface magnetics in the form of transformers and common mode chokes. Transformers and chokes can be discrete components, but integrated solutions that include the RJ-45 connector, resistors, capacitors, and protection are also available. In either case, the transformer will provide a high level of common mode isolation to external voltages, but no protection for metallic (line-to-line) surges. During a metallic transient event, current will flow into one line, through the transformer and back to the source. As the current flows, it charges the windings of the transformer on the line side. Once the surge is removed, the windings on the line side will stop

charging and will transfer its stored energy to the IC side where the PHY IC is located. The magnitude and duration of the surge is attenuated by the inductance of the magnetics. The amount of attenuation will vary by vendor and configuration of the magnetics. It is this transferred energy that must be clamped by the protection circuitry.

A typical protection scheme which utilizes the uClamp3312T is shown in Figure 1. One device is placed across two line pairs and is located on the PHY side of the transformer as close to the magnetics as possible. This is done to minimize parasitic inductance and improve clamping performance. In this design, the isolation voltage of the transformer is relied upon to suppress common mode lightning surges. High voltage capacitors and resistors are commonly utilized from the center tap to ground to aid in transient protection. Metallic surges will be transferred in some form to the PHY side and clamped by the uClamp3312T. The uClamp3312T will turn on when the voltage across it exceeds the punch-through voltage of the device. Low voltage turn on is important since many PHY chips have integrated ESD protection structures. These structures are for protection of the device during manufacture and are not designed to handle large amounts of energy. Should they turn on before the external protection, they can be damaged resulting in failure of the PHY chip.

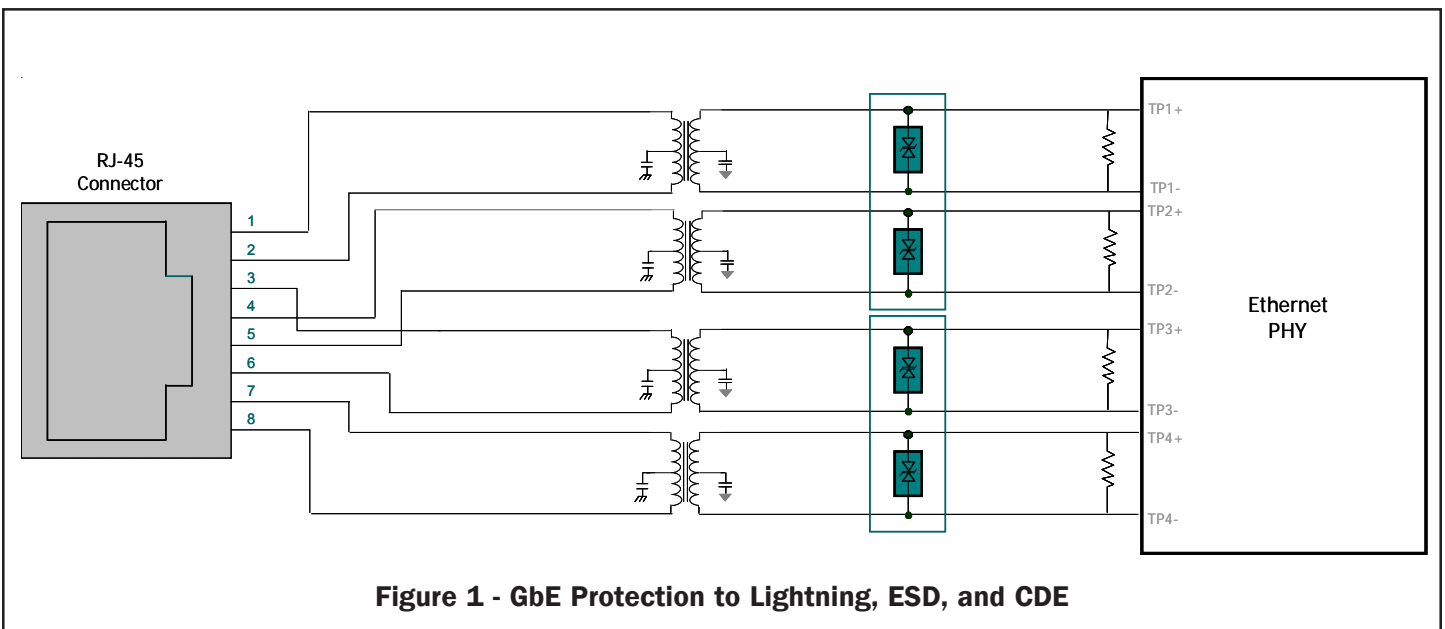


Figure 1 - GbE Protection to Lightning, ESD, and CDE

Point A



Point B



Point C



Point D



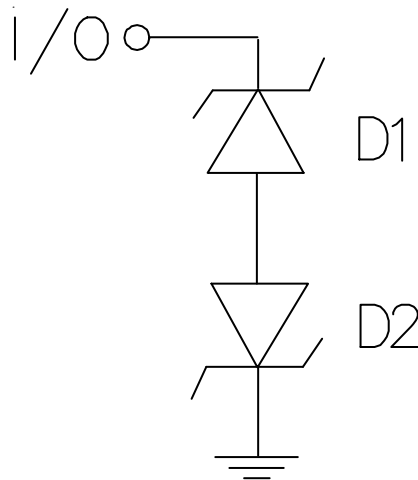
Point F



Point H



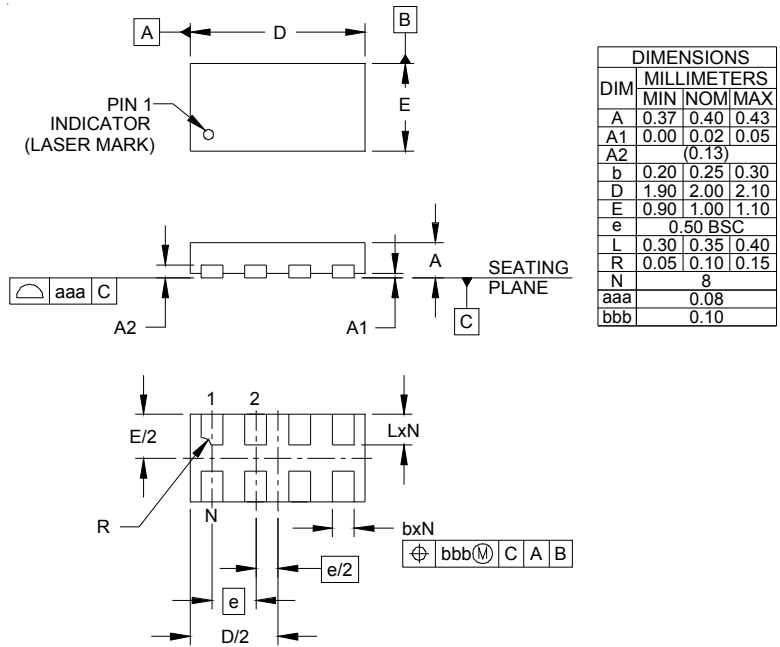
Figure 2 - Typical IEEE 802.3 Template Test Results (With uClamp3312T)

PROTECTION PRODUCTS
Applications Information - Spice Model

Spice Model

uClamp3312T Spice Parameters			
Parameter	Unit	D1 (TVS)	D2 (TVS)
IS	Amp	1E-20	1E-20
BV	Volt	2.8	2.8
VJ	Volt	0.7	0.7
RS	Ohm	0.2	0.2
IBV	Amp	1E-3	1E-3
CJO	Farad	10E-12	1E-12
TT	sec	2.541E-9	2.541E-9
M	--	0.05	0.05
N	--	1.1	1.1
EG	eV	1.11	1.11

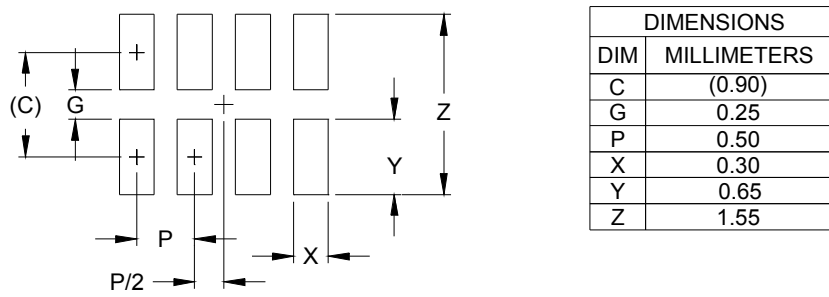
PROTECTION PRODUCTS

Outline Drawing - SLP2010N8T



NOTES:
1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES).

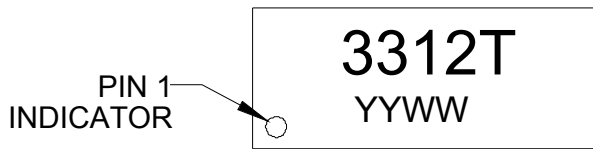
Land Pattern - SLP2010N8T



NOTES:
1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES).
2. THIS LAND PATTERN IS FOR REFERENCE PURPOSES ONLY. CONSULT YOUR MANUFACTURING GROUP TO ENSURE YOUR COMPANY'S MANUFACTURING GUIDELINES ARE MET.

PROTECTION PRODUCTS

Marking Code



YYWW = Date Code

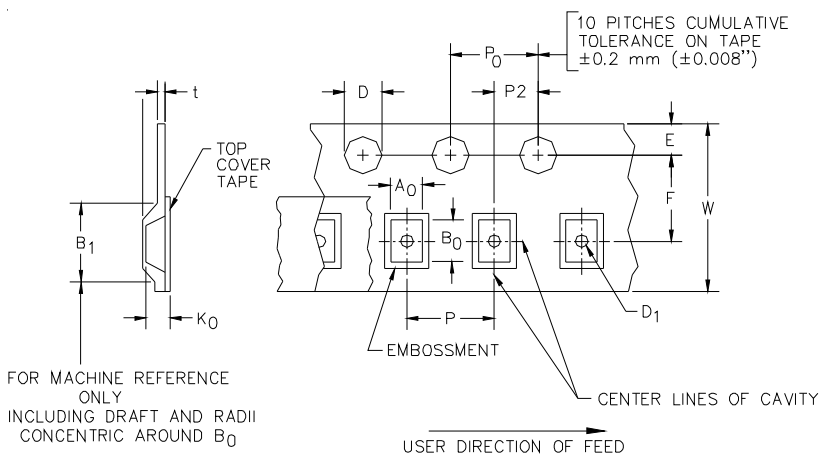
Ordering Information

Part Number	Working Voltage	Qty per Reel	Reel Size
uClamp3312T.TCT	3.3V	3,000	7 Inch

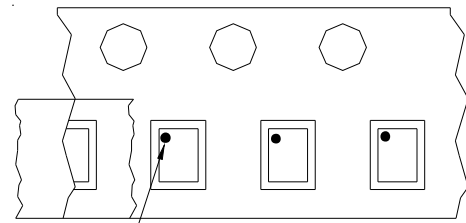
Notes:

1) MicroClamp, uClamp and μ Clamp are marks of Semtech Corporation

Tape and Reel Specification



FOR MACHINE REFERENCE ONLY INCLUDING DRAFT AND RADII CONCENTRIC AROUND B₀



Pin 1 Location

User Direction of feed

Device Orientation in Tape

A0	B0	K0
1.21 +/-0.05 mm	2.21 +/-0.05 mm	0.66 +/-0.05 mm

Tape Width	B, (Max)	D	D1	E	F	P	P0	P2	T	W
8 mm	4.2 mm (.165)	1.5 + 0.1 mm - 0.0 mm (0.59 +.005 - .000)	0.4 mm ±0.25 (.031)	1.750±.10 mm (.069±.004)	3.5±0.05 mm (.138±.002)	4.0±0.10 mm (.157±.004)	4.0±0.1 mm (.157±.004)	2.0±0.05 mm (.079±.002)	0.254±0.02 mm (.016)	8.0 mm + 0.3 mm - 0.1 mm (.312±.012)

Contact Information

Semtech Corporation
 Protection Products Division
 200 Flynn Rd., Camarillo, CA 93012
 Phone: (805)498-2111 FAX (805)498-3804



Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

Телефон: 8 (812) 309 58 32 (многоканальный)

Факс: 8 (812) 320-02-42

Электронная почта: org@eplast1.ru

Адрес: 198099, г. Санкт-Петербург, ул. Калинина, дом 2, корпус 4, литера А.